

LQ035Q7DH07

TFT-LCD Module

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SHARP CORPORATION

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Mobile LCD Design Center
Mobile LCD Group II

DEVICE SPECIFICATION FOR

TFT-LCD module

MODEL No. **LQ035Q7DH07**

CUSTOMER'S APPROVAL

DATA

BY

PRESENTED

BY

FOR 

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SHARP CORPORATION

SPEC No.:LCP-06012

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(1) Application

This specification applies to LQ035Q7DH07

(2) Overview

This module is a color active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor), named AD-TFT (Advanced TFT). It is practicable in both transmissive-type and reflection-type modes. It is composed of a color TFT-LCD panel, driver ICs, an FPC, a back light, and a back sealed casing. It isn't composed control circuit. Graphics and texts can be displayed on a 240×3×320 dots panel with 262,144 colors by supplying.

Optimum view angle is 6 o'clock. An inverted display mode is selective in the vertical or the horizontal direction.

(3) Mechanical specifications

Table 1

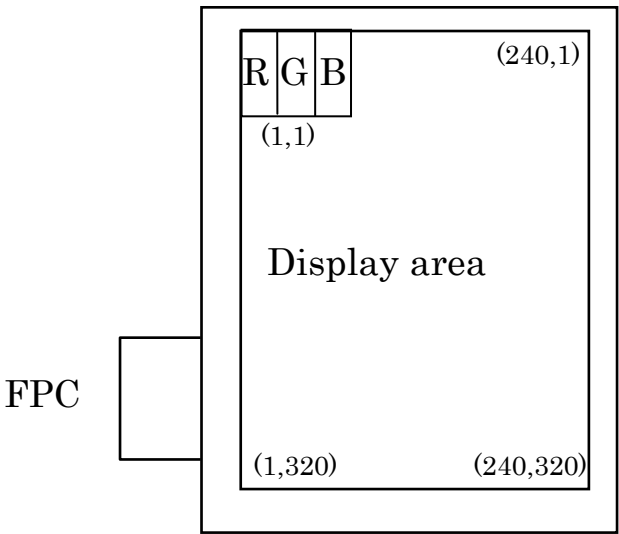
Parameter	Specifications	Units	Remarks
Screen size (Diagonal)	8.9 [3.52"] Diagonal	cm	
Display active area	53.64(H)×71.52(V)	mm	
Pixel format	240(H)×320(V) (1 pixel = R+G+B dots)	pixels	
Pixel pitch	0.2235(H)×0.2235(V)	mm	
Pixel configuration	R,G,B vertical stripe		
Unit outline dimension	65.0(W)×86.2(H)×3.2(D)	mm	【Note3-1】
Mass	34	g	Typ.
Surface hardness	3H		

【Note 3-1】

Excluding protrusion, including FPC cover portion

For detailed measurements and tolerances, please refer to Fig. 1.

(4) Pixel configuration



(5) Input/Output terminal

5-1) TFT-LCD panel driving section

Table2 Recommendation CN : HIROSE FH12A-50S-0.5SH(55) or FH12-50S-0.5SH(55)

Pin No.	Symbol	I/O	Description	Remarks
1	VL1	I	Power supply for LED (High voltage)	
2	NC	-		
3	VL2	I	Power supply for LED (Low voltage)	
4	VEE	-	Power supply of gate driver(low level)	
5	VSHD	-	Power supply of digital	
6	DGND	-	Ground(digital)	
7	CLS	I	Clock signal of gate driver	
8	DGND	-	Ground(digital)	
9	SPS	I	Start signal of gate driver	
10	U/L	I	Selection for vertical scanning direction	【Note5-1】
11	MOD	I	Control signal of gate driver	【Note5-2】
12	VDD	-	Power supply of gate driver(high level)	
13	VCOM	I	Common electrode driving signal	
14	DGND	-	Ground(digital)	
15	SPR	I/O	Sampling start signal	
16	DGND	-	Ground(digital)	
17	VSHA	-	Power supply(analog)	
18	LBR	I	Selection for horizontal scanning direction	【Note5-3】
19	PS	I	Power save signal (Please don't carry out use by "Low" fixation)	
20	REV	I	reverse control signal	【Note5-4】
21	DGND	-	Ground(digital)	
22	B5	I	BLUE data signal(MSB)	
23	B4	I	BLUE data signal	
24	B3	I	BLUE data signal	
25	B2	I	BLUE data signal	
26	B1	I	BLUE data signal	
27	B0	I	BLUE data signal(LSB)	
28	LP	I	Data latch signal of source driver	
29	DGND	-	Ground(digital)	
30	SPL	I/O	Sampling start signal	
31	DGND	-	Ground(digital)	
32	DCLK	I	Data sampling clock signal	
33	DGND	-	Ground(digital)	
34	G5	I	GREEN data signal(MSB)	
35	G4	I	GREEN data signal	
36	G3	I	GREEN data signal	
37	G2	I	GREEN data signal	
38	G1	I	GREEN data signal	
39	G0	I	GREEN data signal(LSB)	

Pin No.	Symbol	I/O	Description	Remarks
40	DGND	-	Ground(digital)	
41	R5	I	RED data signal(MSB)	
42	R4	I	RED data signal	
43	R3	I	RED data signal	
44	R2	I	RED data signal	
45	R1	I	RED data signal	
46	R0	I	RED data signal(LSB)	
47	AGND	-	Ground(analog)	
48	COM	O	Produce REV signal with the amplitude of AGND-VSHA	【Note5-4】
49	DGND	-	Ground(digital)	
50	DGND	-	Ground(digital)	

【Note5-1】 Selection for vertical scanning direction

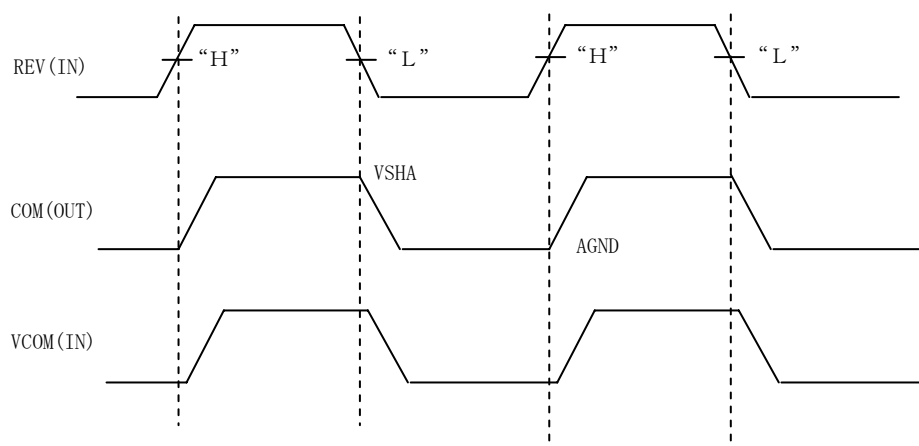
U/L	Scanning direction (Pixel configuration)
Low	Normal scanning (X , 1) ↓ (X , 320)
High	Inverted scanning (X , 1) ↑ (X , 320)

【Note5-2】 See section(7-1)-(A) ” Cautions when you turn on or off the power supply”.

【Note5-3】 Selection for horizontal scanning direction

LBR	SPL	SPR	Scanning direction (Pixel configuration)
High	Input	Output	Normal scanning (1,Y) → (240,Y)
Low	Output	Input	Inverted scanning (1,Y) ← (240,Y)

【Note5-4】



(6)Absolute Maximum Ratings

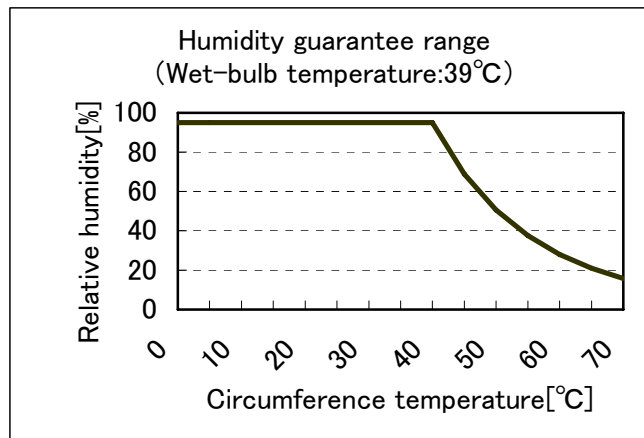
Table 3

Parameter	Symbol	Condition	Ratings	Unit	Remark
Power supply(source/Analog)	VSHA	Ta=25°C	-0.3 to +7.0	V	
Power supply(source/Digital)	VSHD	Ta=25°C	-0.3 to +7.0	V	
Power supply (gate)	VDD	Ta=25°C	-0.3 to +35.0	V	
Power supply (gate)	VDD - VEE	Ta=25°C	-0.3 to +35.0	V	
Input voltage (Digital)	VID	Ta=25°C	-0.3 to VSHD+0.3	V	[Terminal A]
Operating temperature (panel surface)	Topp	-	-10 to +70	°C	【Note6】
Storage temperature	Tstg	-	-25 to +70	°C	【Note6】

[Terminal A] MOD,U/L,SPS,CLS,SPL,R0 to R5,G0 to G5,B0 to B5,LP,DCLK,LBR,SPR,PS,REV

【Note6】 Humidity: 95%RH Max.(at Ta ≤ 40°C). Maximum wet-bulb temperature is less than 39°C (at Ta > 40°C).

Condensation of dew must be avoided.



The maximum humidity in the temperature

(7)Electrical characteristics

7-1) Recommended operating conditions

A) TFT-LCD panel driving section

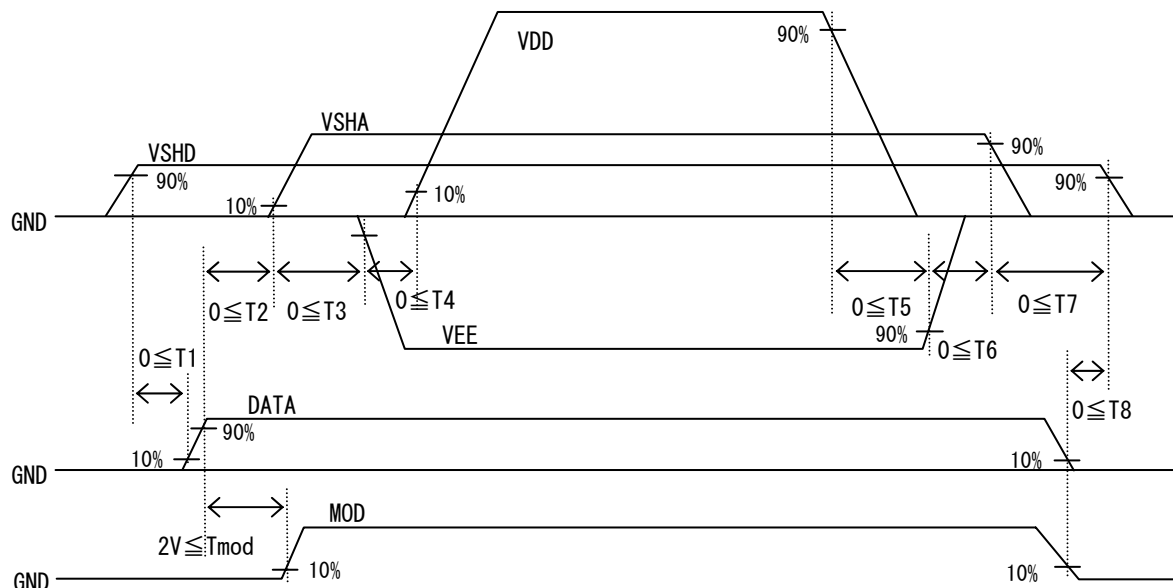
Table 4

GND=0V

Parameter		Symbol	Min.	Typ.	Max.	Unit	Remarks
Supply voltage for source driver (Analog)		V _{SHA}	+4.5	+5.0	+5.5	V	
Supply voltage for source driver (Digital)		V _{SHD}	+3.0	+3.3	+3.6	V	
Supply voltage for gate driver	High voltage	V _{DD}	+14.5	+15.0	+15.5	V	
	Low voltage	V _{EE}	-10.5	-10.0	-9.5	V	
Input voltage for Source driver (Low)		V _{ILS}	GND	-	0.2V _{SHD}	V	【Note 7-1】
Input voltage for Source driver (High)		V _{IHS}	0.8V _{SHD}	-	V _{SHD}	V	【Note 7-1】
Input current for Source driver (Low)		I _{ILS}	-	-	30	μA	【Note 7-1】
Input current for Source driver (High)	I _{IHS1}		-	-	30	μA	【Note 7-2】
	I _{IHS2}		-	-	1200	μA	【Note 7-3】
Input voltage for Gate driver (Low)		V _{ILG}	GND	-	0.2V _{SHD}	V	【Note 7-4】
Input voltage for Gate driver (High)		V _{IHG}	0.8V _{SHD}	-	V _{SHD}	V	【Note 7-4】
Input current for Gate driver (Low)		I _{ILG}	-	-	4	μA	【Note 7-4】
Input current for Gate driver (High)		I _{IHG}	-	-	4	μA	【Note 7-4】
Common electrode driving signal	AC component	V _{COMAC}	-	±2.5	±2.6	V _{P-P}	【Note 7-5】
	DC component	V _{COMDC}	-0.8	+0.2	+1.2	V	【Note 7-5】

※Cautions when you turn on or off the power supply

- ① Turn on or off the power supply with simultaneously or the following sequence.
- ② The input signal of “MOD” Terminals (Pin No.11) must be low voltage when turning on the power supply, and it is held until more than double vertical periods after DATA are turned on completely. After then, it must be held high voltage until turning off the power supply. (Connect Pin No.11 terminals to the same signal.)



【Note 7-1】 DCLK,SPL,SPR,LBR,LP,PS,REV,R0 to R5,G0 to G5 and B0 to B5 terminals are applied.

【Note 7-2】 DCLK,SPL,SPR,LBR,LP,REV,R0 to R5,G0 to G5 and B0 to B5 terminals are applied.

【Note 7-3】 PS terminal is applied.

【Note 7-4】 MOD,CLS,SPS and U/L terminals are applied.

【Note 7-5】 VCOMAC should be alternated on VCOMDC every 1 horizontal period and 1 vertical period.

VCOMDC bias is adjusted so as to minimize flicker or maximum contrast every each module.

B) Back light driving section

Table 5

Ta=25°C

Parameter	Symbol	MIN	TYP	MAX	Units	Remarks terminal
LED voltage	V _L	-	19.2	21.6	V	
LED current	I _L	-	20	22	mA	
Power consumption	W _L	-	0.384	-	W	【Note 7-6】

【Note 7-6】 Calculated reference value(I_L×V_L)

7-2) Timing Characteristics of input signals

Table 6 AC Characteristics (1)

(V_{SHA}=+5V, V_{SHD}=+3.3V, Ta=25°C)

Parameter		Symbol	Min.	Typ.	Max.	Unit	Remark
Clock frequency of source driver		fCK	4.5	-	6.8	MHz	
Source driver	Rising time of clock	T _{cr}	-	-	20	ns	DCLK
	Falling time of clock	T _{cf}	-	-	20	ns	
	Pulse width (High level)	T _{cwh}	40	-	-	ns	
	Pulse width (Low level)	T _{cwl}	40	-	-	ns	
	Frequency of start pulse	f _{sp}	16.5	-	28	kHz	SPL, SPR
	Setup time of start pulse	T _{susp}	15	-	-	ns	
	Hold time of start pulse	T _{hsp}	10	-	-	ns	
	Pulse width of start pulse	T _{wsp}	-	-	1.5/fck	ns	
	Setup time of latch pulse	T _{sulp}	20	-	-	ns	LP
	Hold time of latch pulse	T _{hlp}	20	-	-	ns	
	Pulse width of latch pulse	T _{wlp}	60	-	-	ns	
	Setup time of PS	T _{sup}	0	-	-	μs	PS
	Setup time of PS	T _{sulps}	1	-	-	μs	
	Hold time of PS	T _{hps}	0	-	-	μs	
	Hold time of PS	T _{hlps}	30	-	-	ns	
Set up time of data		T _{sud}	15	-	-	ns	R0 to R5,G0 to G5 ,B0 to B5
Hold time of data		T _{hd}	10	-	-	ns	
Gate driver	Clock frequency	f _{cls}	16.5	-	28	kHz	CLS
	Pulse width of clock(Low)	T _{wlcls}	5	-	(1/fcls)-30	μs	
	Pulse width of clock(High)	T _{whcls}	30	-	-	μs	
	Rising time of clock	T _{rcls}	-	-	100	ns	
	Falling time of clock	T _{fccls}	-	-	100	ns	
	Setup time of clock	T _{sucls}	3	-	-	μs	
	Hold time of clock	T _{hcls}	0	-	-	μs	
	Frequency of start pulse	f _{sps}	58	-	86	Hz	SPS
	Setup time of start pulse	T _{susps}	100	-	-	ns	
	Hold time of start pulse	T _{hsps}	300	-	-	ns	
	Rising time of start pulse	T _{rsps}	-	-	100	ns	
	Falling time of start pulse	T _{fsps}	-	-	100	ns	
Vcom	Setup time of Vcom	T _{svcom}	0	-	-	μs	Vcom
	Hold time of Vcom	T _{hvcom}	1	-	-	μs	

【Note 7-7】 There must be only one up-edge of DCLK (includes T_{susp} and T_{hsp} time) in the period of SPL="Hi".

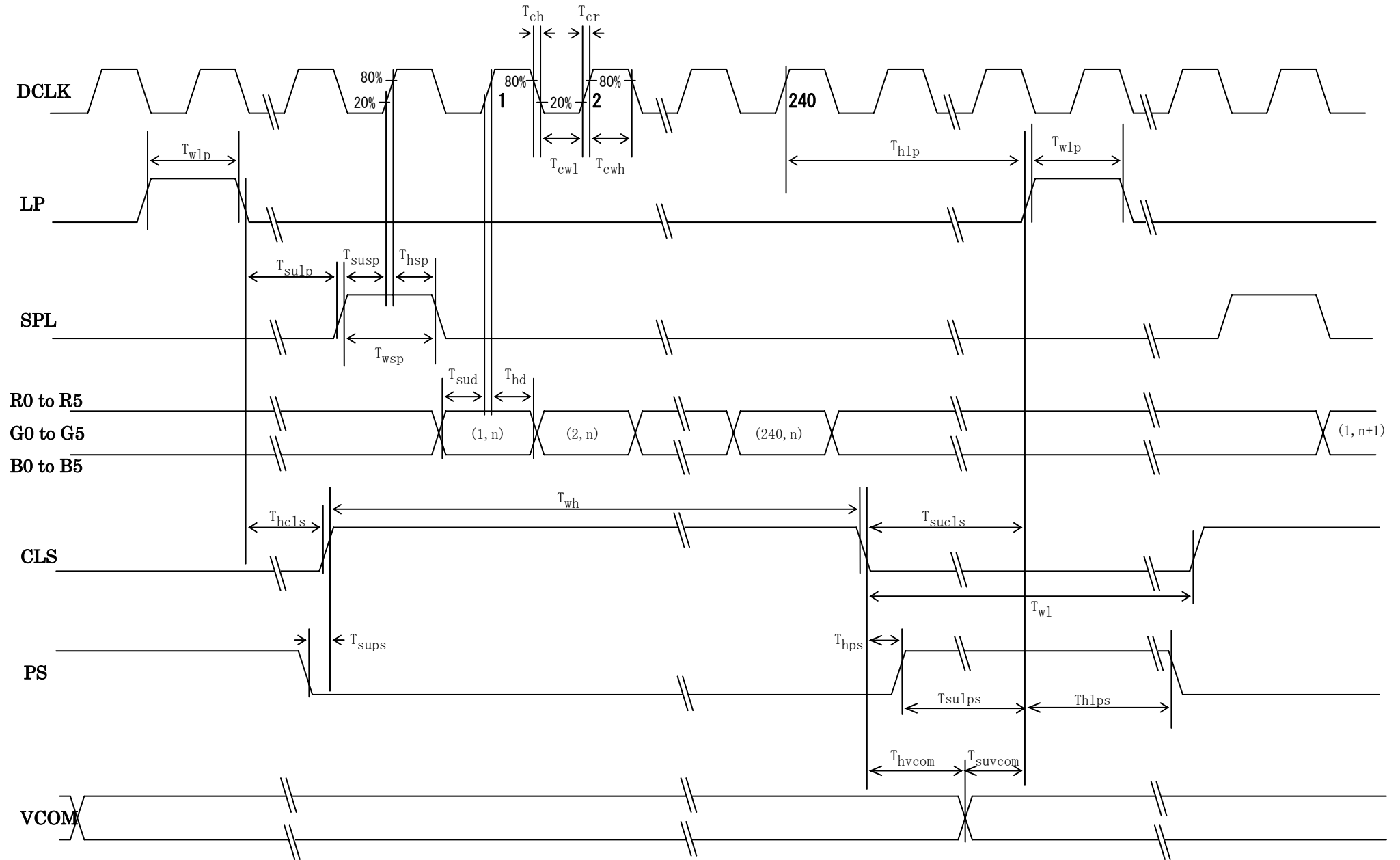


Fig.(a) Horizontal timing chart

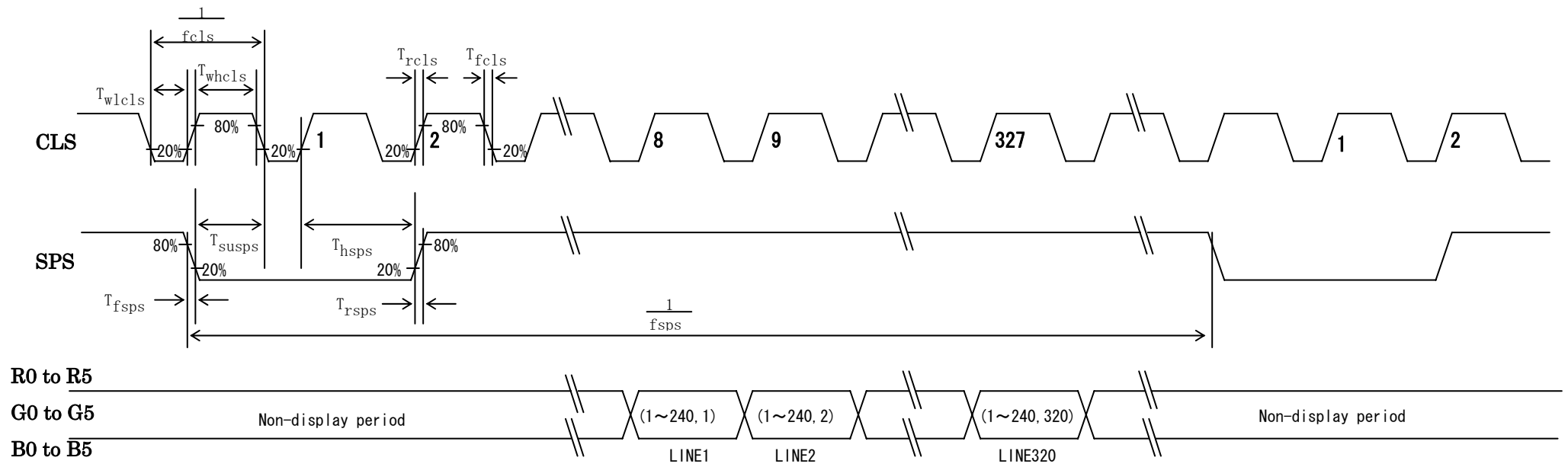


Fig.(b) Vertical timing chart

7-3) Power consumption

Measurement condition: SPS=60Hz, CLS=15.73kHz, SPL=15.73kHz, DCLK=6.3MHz

The term of PS="Lo" in one horizontal period ... 37μsec (234DCLK)

Ta=25°C

Table 7

when normal scan mode

Parameter		Sym	Conditions	Min.	Typ.	Max.	Unit	Remarks
Source current	Analog	ISHA	V _{SHA} =+5.0V	—	3.0	6.0	mA	【Note 7-8】
	Digital	ISHD	V _{SHD} =+3.3V	—	1.5	3.0	mA	【Note 7-8】
Gate current	High	I _{DD}	V _{DD} =+15.0V	—	0.05	0.10	mA	【Note 7-9】
	Low	I _{EE}	V _{EE} =-10.0V	—	-0.05	-0.10	mA	【Note 7-9】

【Note 7-8】 Vertical stripe pattern alternating 21 gray scale (GS21) with 42 gray scale (GS42) every 1 dot.

【Note 7-9】 64-Gray-bar vertical pattern (GS0 to GS63 for horizontal way)

(8) Input Signals, Basic Display Color and Gray Scale of Each Color

Table 8

	Colors &	Data signal																			
	Gray scale	Gray Scale	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	B0	B1	B2	B3	B4	B5	
Basic color	Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Blue	-	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	
	Green	-	0	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	
	Cyan	-	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	
	Red	-	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	
	Magenta	-	1	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	-	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale of red	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	↓	↓						↓						↓						
	↓	↓	↓						↓						↓						
	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
	↓	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	
Gray Scale of green	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	
	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	
	↑	↓	↓						↓						↓						
	↓	↓	↓						↓						↓						
	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0	
	↓	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	
	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0	
Gray Scale of bleu	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	
	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	
	↑	↓	↓						↓						↓						
	↓	↓	↓						↓						↓						
	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	
	↓	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	
	Bleu	GS63	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	

0: Low level voltage 1: High level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.

(9)Optical characteristics

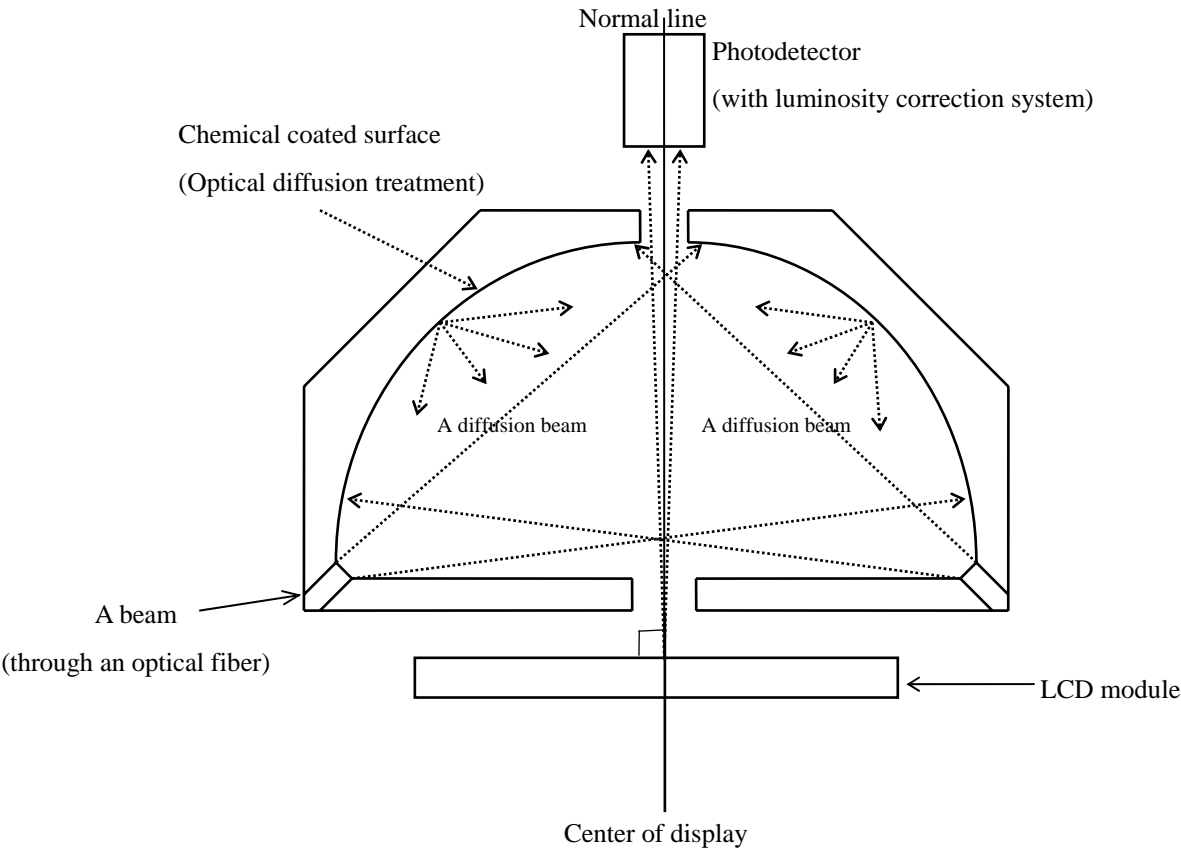
9-1)Not driving the Back light condition

Table 9 (VSHA=+5V, VSHD=+3.3V, VDD=+15V, VEE=-10V, Ta=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remarks
Viewing angle range		θ21,22	CR≥1.5	35	50	-	degree	[Note 9-1,2]
		θ11		35	50	-	degree	
		θ12		35	50	-	degree	
Contrast ratio		CRmax	θ =0°	2	3	-		[Note 9-2,4]
Response time	Rise	τ r	θ =0°	-	30	60	ms	[Note 9-3]
	Fall	τ d		-	50	100	ms	
White chromaticity		x		0.273	0.323	0.373		[Note 9-4]
		y		0.303	0.353	0.403		
Red chromaticity		x		0.310	0.360	0.410		
		y		0.267	0.317	0.367		
Green chromaticity		x		0.257	0.307	0.357		
		y		0.322	0.372	0.422		
Blue chromaticity		x		0.194	0.244	0.294		
		y		0.222	0.272	0.322		
Reflection ratio		R	θ =0°	2.5	4	-	%	[Note 9-5]

* The measuring method of the optical characteristics is shown by the following figure.

* A measurement device is Otsuka luminance meter LCD5000. (With the diffusion reflection unit.)



Measuring method (a) for optical characteristics

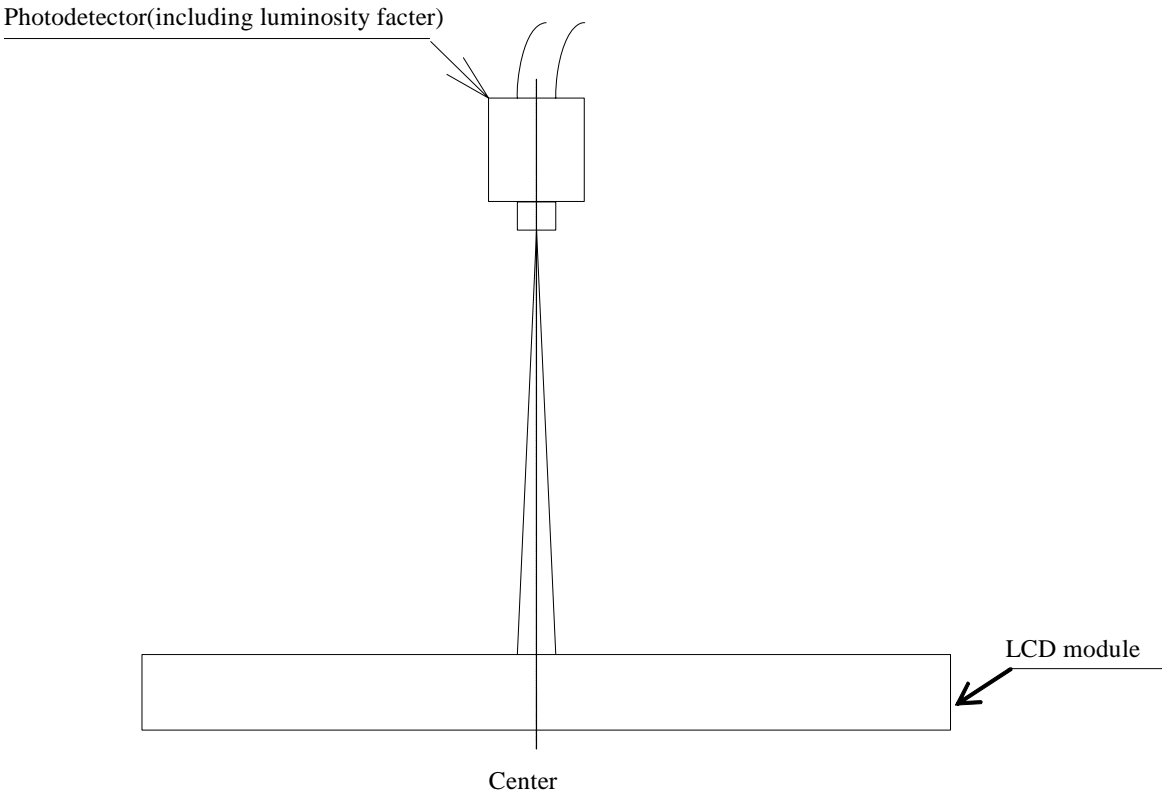
9-2)Driving the Back light condition

Table 10 (V_{SHA}=+5V, V_{SHD}=+3.3V, V_{DD}=+15V, V_{EE}=-10V, Ta=25°C)

Parameter		Symbol	Condition	Min	Typ	Max	Unit	Remarks
Viewing angle range		θ21,22	CR≥2	30	40	-	degree	[Note 9-1,2,6]
		θ11		40	50	-	degree	
		θ12		30	40	-	degree	
Contrast ratio		Crmax	θ = 0°	50	80	-		[Note 9-2]
Response time	Rise	τr		-	30	60	ms	[Note 9-3]
	Fall	τd		-	50	100	ms	
White chromaticity		x		0.250	0.300	0.350		
		y		0.280	0.330	0.380		
Red chromaticity		x		0.470	0.520	0.570		
		y		0.280	0.330	0.380		
Green chromaticity		x		0.280	0.330	0.380		
		y		0.430	0.480	0.530		
Blue chromaticity		x		0.110	0.160	0.210		
		y		0.140	0.190	0.240		
Brightness		Y	θ = 0°	180	250	-	cd/m²	I _L =20mA
LED life time		LL	I _L =20mA	—	5,000	—	hour	[Note 9-7]

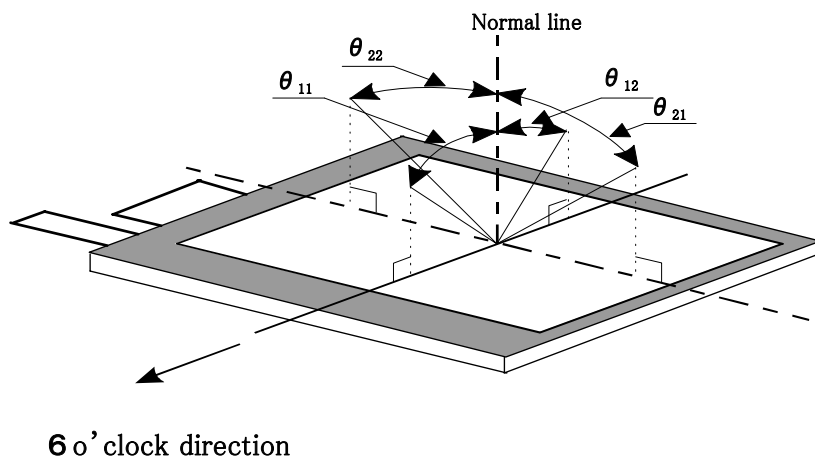
* The measuring method of the optical characteristics is shown by the following figure.

* A measurement device is TOPCON luminance meter BM-5A. (Viewing cone 1)



Measuring method (c) for optical characteristics

[Note 9-1] Viewing angle is defined as follows.



Definition for viewing angle

[Note 9-2] Definition of contrast ratio:

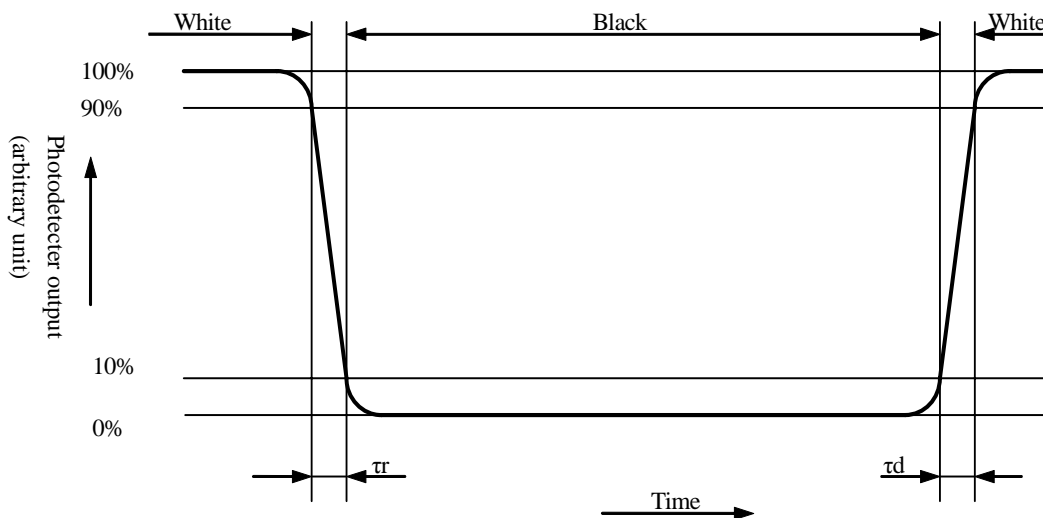
The contrast ratio is defined as follows:

$$\text{Contrast ratio (CR)} = \frac{\text{Photodetector output with all pixels white (GS63)}}{\text{Photodetector output with all pixels black (GS0)}}$$

$$V_{\text{COMAC}} = 5.0 \text{ V}_{\text{P-P}}$$

[Note 9-3] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



[Note 9-4] A measurement device is Minolta CM-2002.

[Note 9-5] Definition of reflection ratio:

$$\text{Reflection ratio} = \frac{\text{Light detected level of the reflection by the LCD module}}{\text{Light detected level of the reflection by the standard white board}}$$

[Note 9-6] A measurement device is ELDIM EZContrast

[Note 9-7] This is the reference value. The White-LED life time is defined as a time when brightness not to become under 50% of the original value. (at $T_a = 25^\circ\text{C}$)

(10) Display quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standards for TFT-LCD.

(11) Mechanical characteristics

11-1) External appearance

See Fig. 1

11-2) FPC (for LCD panel) characteristics

(1) Specific connector

FH12A-50S-0.5SH(55) or FH12-50S-0.5SH(55) (HIROSE)

(2) Bending endurance of the bending slits portion

No line of the FPC is broken for the bending test (Bending radius=0.6mm and angle=90°) in 30 cycles.

(12) Handling Precautions

12-1) Insertion and taking out of FPCs

Be sure insert and take out of the FPC into the connector of the set after turning off the power supply on the set side.

12-2) Handling of FPCs

The FPC for LCD panel shall be bent only slit portion. The bending slit shall be bent uniformly on the whole slit portion with bending radius larger than 0.6mm, and only inner side (back side of the module). Don't bend it outer side (display surface side).

Don't give the FPCs too large force, for example, hanging the module with holding FPC.

12-3) Installation of the module

On mounting the module, be sure to fix the module on the same plane. Taking care not to warp or twist the module.

12-4) Precautions when mounting

- (1) If water droplets and oil attaches to it for a long time, discoloration and staining occurs. Wipe them off immediately.
- (2) Glass is used for the TFT-LCD panel. If it is dropped or bumped against a hard object, it may be broken. Handle it with sufficient care.
- (3) As the CMOS IC is used in this module, pay attention to static electricity when handling it. Take a measure for grounding on the human body.

12-5) Others

- (1) The liquid-crystal is deteriorated by ultraviolet rays. Do not leave it in direct sunlight and strong ultraviolet rays for many hours.
- (2) If it is kept at a temperature below the rated storage temperature, it becomes coagulated and the panel may be broken. Also, if it is kept at a temperature above the rated storage temperature, it becomes isotropic liquid and does not return to its original state. Therefore, it is desirable to keep it at room temperature as much as possible.
- (3) If the LCD breaks, don't put internal liquid crystal into the mouth. When the liquid crystal sticks to the hands, feet and clothes, wash it out immediately.
- (4) Wipe off water drop or finger grease immediately. Long contact with water may cause discoloration or spots.
- (5) Observe general precautions for all electronic components.
- (6) VCOM must be adjusted on condition of your final product. No adjustment causes the deterioration for display quality.
- (7) Static image should not be displayed more than 5 minutes in order to prevent from occurrence of residual image.

(13) Reliability Test Conditions for TFT-LCD Module

Table 11

No.	Test items	Test conditions
1	High temperature storage test	Ta=+70°C 240h
2	Low temperature storage test	Ta=-25°C 240h
3	High temperature and high humidity operating test	Tp=+40°C , 95%RH 240h (But no condensation of dew)
4	High temperature operating test	Tp=+70°C 240h
5	Low temperature operating test	Tp=-10°C 240h
6	Electro static discharge test	±200V/200pF(0Ω) to Terminals(Contact) (1 time for each terminals) ±8kV/150pF(330Ω) to Housing bezel or TP(Contact) ±15kV/150pF(330Ω) to Housing bezel or TP(in Air)
7	Shock test	980 m/s ² , 6 ms ±X, ±Y, ±Z 3 times for each direction (JIS C0041, A-7 Condition C)
8	Vibration test	Frequency range: 10Hz to 55Hz Stroke: 1.5 mm Sweep: 10Hz to 55Hz X,Y,Z 2 hours for each direction (total 6 hours) (JIS C0040,A-10 Condition A)
9	Heat shock test	Ta=-25 to +70°C / 5 cycles (1h) (1h)
10	FPC Bending Test	Bending 30 times by bending radius R0.6mm and angle=90° (LCD FPC)

【Note】 Ta = Ambient temperature, Tp = Panel temperature

【Check items】

Test No.1 to 9:

In the standard condition, there shall be no practical problems that may affect the display function.

(14) Others

14-1) Indication of lot number

The lot number is shown on a label. Attached location is shown in Fig.1 (Outline Dimensions).

LQ035Q7DH07	○○○○○○○○○○
model No.	lot No.

14-2) Used Regulation of Chemical Substances Breaking Ozone Stratum

Substances with the object of regulating: CFCS, Carbon tetrachloride, Halon 1,1,1-Trichloro ethane (Methyl chloroform)

(a) This LCD module, Constructed part and Parts don't contain the above substances.

(b) This LCD module, Constructed part and Parts don't contain the above substances in processes of manufacture.

14-3) If some problems arise about mentioned items in this document and other items, the user of the TFT-LCD module and SHARP will cooperate and make efforts to solve the problems with mutual respect and good will.

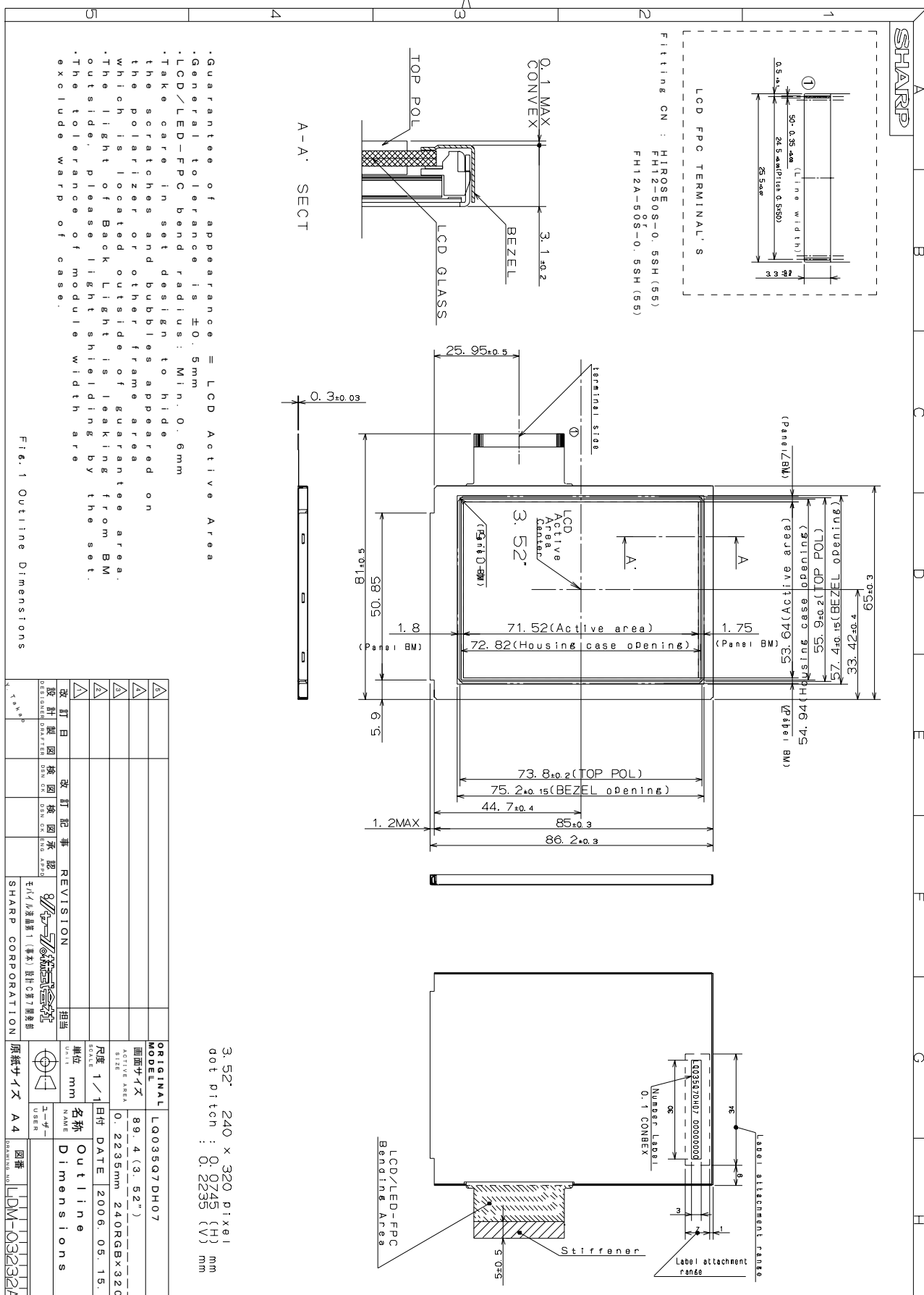
(15) Forwarding form (See Fig.2 Package Form)

- a) Piling number of cartons : Max 8
- b) Package quality in one cartons : 100pcs
- c) Carton size : 575mm × 332mm × 209mm
- d) Total mass of 1 carton filled with full modules: 7450g

Conditions for storage

Environment

- (1)Temperature: 0 to 40°C
- (2)Humidity: 60%RH or less (at 40°C)
No dew condensation at low temperature and high humidity.
- (3)Atmosphere: Harmful gas, such as acid or alkali which bites electronic components and/or wires, must not be detected.
- (4)Period: about 3 months
- (5)Opening of the package: In order to prevent the LCD module from breakdown by electrostatic charges, please control the room humidity over 50%RH and open the package taking sufficient countermeasures against electrostatic charges, such as earth, etc



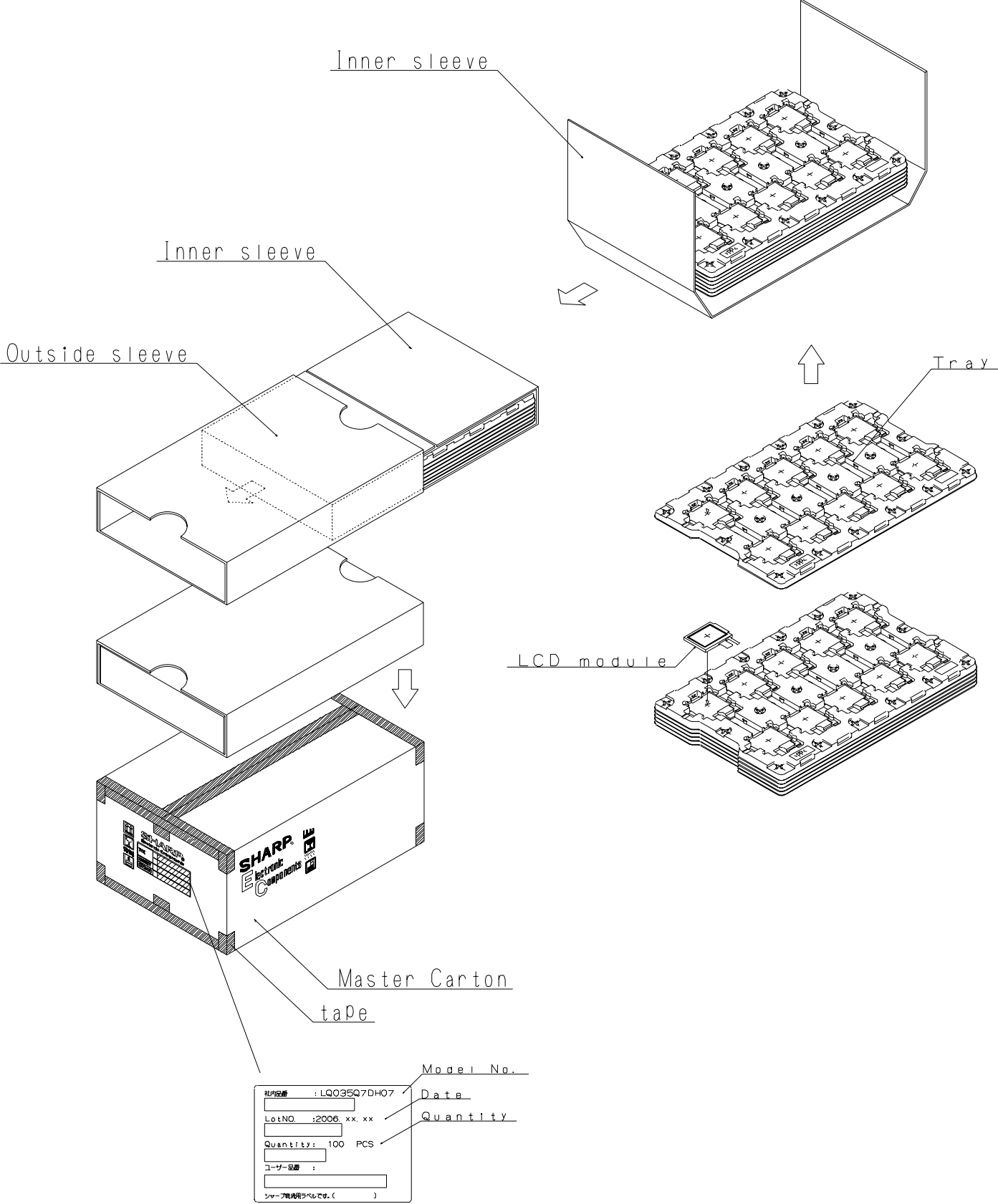


Fig.2 Forwarding form

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